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Contents

v Conference Committee

NOVEL MATERIALS AND PROCESSES

- 12434 02 Height-modulation of diffraction gratings by light-controlled capillary force lithography for structural coloring (Invited Paper) [12434-1]
- 12434 04 Modeling, fabrication, and readout of compact optomechanical accelerometers [12434-3]
- 12434 05 Low-power contactless button system based on MEMS ScAIN pyroelectric detector [12434-4]
- 12434 06 Mechanical tunability in one-dimensional photonic crystals fabricated by direct laser writing [12434-30]
- 12434 07 Optimization processes for three-dimensional microprinting of glass micro-optics [12434-5]

SPECTROMETERS

12434 08	Flexible micro-spectrometer for grape maturation monitoring (Invited Paper) [12434-6]
12434 09	A doubly-encoded single-pixel NIR Hadamard transform spectrometer using DMD [12434-7]
12434 0A	Miniature and multi-spectral spectrometers in consumer goods and wearables [12434-8]
12434 OC	Applications for a broadband NIR spectrometer with scanning mirror device [12434-10]

MEDICAL APPLICATIONS

12434 OF Simultaneous identification of microparticles material nature and size distribution using spectral resonances in MIR-ATR spectroscopy [12434-14]

MICRO-MIRRORS AND SCANNERS

12434 0H Efficient piezoelectric gimbal-less MEMS-mirror with large design flexibility [12434-16]

LIDAR AND 3D IMAGING

- 12434 0J A long-distance 3D face recognition architecture utilizing MEMS-based region-scanning LiDAR (Invited Paper) [12434-18]
- 12434 0K Coherent LiDAR with 2D quasi-static MEMS mirror scanning (Best Paper Award) (Invited Paper) [12434-19]
- 12434 0L MEMS-based indirect time-of-flight scanning LiDAR with parallel-phase demodulation and multipath interference suppression (Best Student Paper Award) [12434-20]
- 12434 0M Array camera architecture for high-resolution smartphone camera modules with low z-height using tunable lenses for channel-individual focus control [12434-21]
- 12434 00 Fiber-based sensor for combustion chamber monitoring: manufacturing challenge [12434-23]

POSTER SESSION

12434 0Q	An integrated optical method to readout μ -Coriolis mass flow sensors [12434-25]
12434 OR	Improved comb drive design for MEMS piston mirror arrays [12434-26]
12434 OS	FEM simulations to optimize a micro mirror array package for a wide operating temperature range [12434-27]
12434 OT	An integrated MEMS thermal emitter with piezoelectric actuation [12434-28]
12434 OV	Non-resonant MOEMS mirror for laser cavity-length tuning [12434-32]
12434 OW	2D MEMS vector scanning mirrors for LIDAR, medical imaging, and high laser power applications [12434-33]
12434 OX	Wafer-level vacuum packaged translatory MEMS mirror with large stroke for compact NIR-FT spectrometers [12434-34]

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